

July 2016

# Chip beads

For power line

**HF-ACC** series (for automobiles)

HFxxACC2012 Type

HFxxACC2012 [0805 inch]\*

\* Dimensions code JIS[EIA]



## Reminders for using these products

Before using these products, be sure to request the delivery specifications.

## Safety reminders

Please pay sufficient attention to the warnings for safe designing when using this products.

<b>⚠</b> Reminders
The storage period is less than 12 months. Be sure to follow the storage conditions (temperature:5 to 40°C, humidity:10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
○ Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
<ul> <li>Before soldering, be sure to preheat components.</li> <li>The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.</li> </ul>
<ul> <li>Soldering corrections after mounting should be within the range of the conditions determined in the specifications.</li> <li>If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.</li> </ul>
When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
<ul> <li>Carefully lay out the coil for the circuit board design of the non-magnetic shield type.</li> <li>A malfunction may occur due to magnetic interference.</li> </ul>
Use a wrist band to discharge static electricity in your body through the grounding wire.
On not expose the products to magnets or magnetic fields.
On not use for a purpose outside of the contents regulated in the delivery specifications.
The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (electric trains, ships, etc.)

set forth in the each catalog, please contact us.

- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment

- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions

### EMC Components



## **Chip beads**

### For power line

Product compatible with RoHS directive
Halogen-free
Compatible with lead-free solders
AEC-Q200

# Overview of HFxxACC2012 type

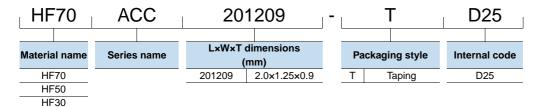
#### **FEATURES**

- O Noise reduction solution for power line.
- Achieves various frequency characteristics by using 3 materials with different features.
- O There is no directivity.

#### APPLICATION

Various ECUs, powertrains, body controls, and car multimedia (telematics).

#### PART NUMBER CONSTRUCTION



### ■ OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

	Temperati	ıre ranges	Package quantity	Individual weight
Type	Operating	Storage		
,,	temperature	temperature*		
	(°C)	(°C)	(pieces/reel)	(mg)
HFxxACC2012	-40 to +125	-40 to +125	2,000	10

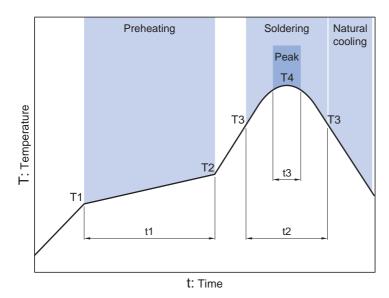
<sup>\*</sup> The storage temperature range is for after the circuit board is mounted.

RoHS Directive Compliant Product: See the following for more details.https://product.tdk.com/info/en/environment/rohs/index.html

O Halogen-free: indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.



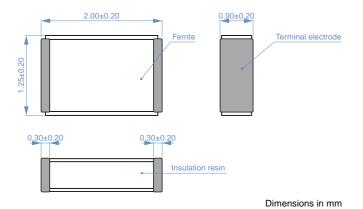
### ■ RECOMMENDED REFLOW PROFILE



Preheating		Soldering	l	Peak	Peak		
Temp.		Time	Temp.	Time	Temp.	Time	
T1	T2	t1	T3	t2	T4	t3	
150°C	180°C	60 to 120s	230°C	30 to 60s	250 to 260°C	10s	

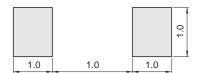


### ■SHAPE & DIMENSIONS





### ■ RECOMMENDED LAND PATTERN



Dimensions in mm



### **■ELECTRICAL CHARACTERISTICS**

#### □CHARACTERISTICS SPECIFICATION TABLE

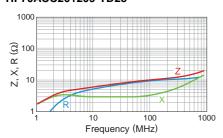
Impedance		DC resistance	Rated current	Part No.
[100MHz]				
<b>(</b> Ω <b>)</b>	Tolerance	( $\Omega$ )max.	(A)max.	
10	±25%	0.03	1.5	HF70ACC201209-TD25
11	±25%	0.03	1.5	HF50ACC201209-TD25
7	±25%	0.03	1.5	HF30ACC201209-TD25



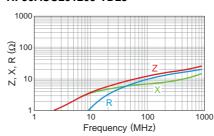
### **■ELECTRICAL CHARACTERISTICS**

### **□Z, X, R VS. FREQUENCY CHARACTERISTICS**

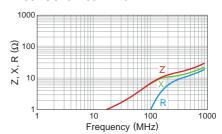
#### HF70ACC201209-TD25



#### HF50ACC201209-TD25



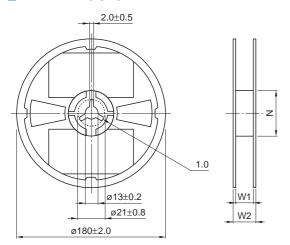
#### HF30ACC201209-TD25





### **■PACKAGING STYLE**

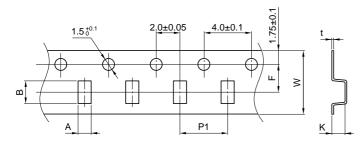
#### **□REEL DIMENSIONS**



Type	W1	W2	N	
HFxxACC2012	8.4+2.0/-0.0	14.4max.	ø60min.	

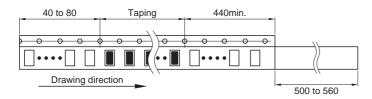
Dimensions in mm

#### **TAPE DIMENSIONS**



Dimensions in mm

Туре	Α	В	F	P1	W	K	t
HFxxACC2012	1.4±0.1	2.25±0.1	3.5±0.05	4.0±0.1	8.0±0.3	1.25max.	0.3max.



Dimensions in mm